



Investigation of the oxygen, nitrogen and water vapour cross-sensitivity to NO₂ of tellurium-based thin films

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Abstract

Effect of O₂, N₂ and H₂O to electrical behavior of tellurium-based films as well as cross-sensitivity to NO₂ gas has been studied at temperatures between 20 and 70°C. The increase of oxygen partial pressure in N₂+O₂ carrier gas results in a nearly linear decreasing of the film resistance. The complete impulsive substitution of nitrogen by oxygen decreases the resistance of the film with ~6% in 1.5h, which is far below the much faster response of 50% with 1.5ppm NO₂. The effect of humidity is more perceptible. At room temperature the resistance of the films increases with 15% at 58% RH, but humidity has negligible effect at temperatures higher than 50°C. At an appropriate temperature, humidity does not interfere with NO₂. Our results suggest that effect of water vapour is due to simple physical adsorption, whereas effect of oxygen and nitrogen is the consequence of “weak” chemisorption of these molecules on the film surface. The NO₂ sensing mechanism involves “strong” chemisorption due to interaction between odd electrons of nitrogen dioxide molecules and lone-pair electrons of tellurium-based chalcogenides.